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Product Change Notification - JAON-13PMYI836 [\(Printer Friendly\)](#)

Date:	24 Apr 2015
Notification subject:	CCB 1547 Initial Notice: Qualification of palladium coated copper with gold flash (CuPdAu) bond wire in selected products of the 200K wafer technology available in 28L UQFN package at NSEB site
Notification text:	<p>PCN Status: Initial notification</p> <p>Microchip Parts Affected: See attachments of affected catalog part numbers (CPN) labeled as... PCN_JAON-13PMYI836_Affected_CPN.xls PCN_JAON-13PMYI836_Affected_CPN.pdf</p> <p>Description of Change: Qualification of palladium coated copper with gold flash (CuPdAu) bond wire in selected products of the 200K wafer technology available in 28L UQFN package at NSEB assembly site.</p> <p>NOTE: Selected products are non-automotive devices. Please review the affected CPN lists (attached) to identify the actual parts affected.</p> <p>Pre Change: Gold (Au) bond wire</p> <p>Post Change: Palladium coated copper with gold flash (CuPdAu) bond wire</p> <p>Impacts to Data Sheet: None</p> <p>Reason for Change: To improve manufacturability and qualify CuPdAu bond wire at NSEB assembly site.</p> <p>Change Implementation Status: In Progress</p> <p>Estimated First Ship Date: October 1, 2015 (date code: 1540)</p> <p>NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.</p> <p>Markings to Distinguish Revised from Unrevised Devices: Traceability code</p> <p>Revision History: April 24, 2015: Issued initial notification.</p> <p>The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.</p>
Attachment(s):	PCN_JAON-13PMYI836_Qual_Plan.pdf PCN_JAON-13PMYI836_Affected_CPN.pdf PCN_JAON-13PMYI836_Affected_CPN.xls

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